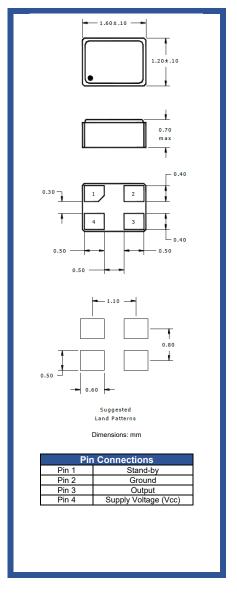
# ISM16 Series

**Product Feature:** 

CMOS Output Low Jitter, Non-PPL Based Output Wide Range of Supply Voltage (1.8 to 3.3V) Stand-by Function on Pin 1 RoHS Compliant Compatible Leadfree Processing **Applications:** 

Fibre Channel Server & Storage 802.11 / Wifi Sonet/SDH T1/E1, T3/E3

Frequency	3.000000 MHz to 80.000000 MHz		
Output Level CMOS	Logic "0" = 0.4 V max Logic "1" = Vcc – 0.4 V min		
Duty Cycle	See Duty Cycle Table in Part Number Guide		
Rise / Fall Time	4.5 nSec max (10% to 90% of waveform)		
Output Load	15pF max		
Frequency Stability	See Frequency Stability Table in Part Number Guide (Note 1)		
Start-up time	2.0 mSec max with Vcc = +3.30 VDC 5.0 mSec max with Vcc = +1.80 VDC		
Stand By Terminal Function (Pin 1)	0.7 Vcc min = Output enable 0.3 Vcc max = Oscillation stop and High impedance output		
Supply Voltage (Vcc)	See Input Voltage Table in Part Number Guide (Tolerance = ±10%)		
Current During Standby During Operation	10 μA max 2.5 typ., 3.5 mA max (1.8 V, 15 pF load @ 50.000MHz) 3.5 typ., 5.0 mA max (1.8 V, 15 pF load @ 80.000MHz) 4.2 typ., 6.0 mA max (3.3 V, 15 pF load @ 50.000MHz) 6.0 typ., 8.5 mA max (3.3 V, 15 pF load @ 80.000MHz)		
Aging	± 3.0 ppm max @ +25°C First Year		
Operating Temperature Range	See Operating Temperature Table in Part Number Guide		
Storage Temperature Range	-40°C to +85°C		
Random Jitter (RJ)	2.9 pSec typical		
Total Jitter (TJ)	40.0 pSec typical TJ = n x RJ were n ≈ 14.1, BER = 10 <sup>-12</sup>		
Phase Jitter	1.0 pSec max Offset frequency = 12 kHz to 5.000MHZ		



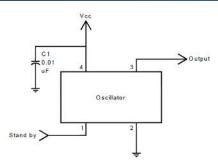
### Notes:

- 1. Includes room temperature tolerance and stability over operating temperature.
- 2. A 0.01 F bypass capacitor is recommended between Vcc (Pin 4) and GND (Pin 2) to minimize power supply noise

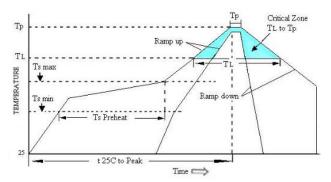
Part Numb	er Guide	Sample Pa	rt Number:	ISM16-3153A-20.000 MHz		
Package	Input Voltage	Operating Temperature	Symmetry (Duty Cycle)	Output	Stability (in ppm)	Frequency
	1 = 1.8 V	1 = 0° C to +70° C	5 = 45 / 55 Max.	3 = 15 pF	*A = ±25	
	3 = 3.3 V	2 = -40° C to +85° C	6 = 40 / 60 Max.		B = ±50	
ISM16 -	6 = 2.5 V	3 = -20° C to +70° C			C = ±100	-20.0000 MHZ
		5 = -30° C to +85° C			*F = ±20	
					G = ±30	
*Note available	e for all temperatur	e ranges				



### **Typical Application:**



## Pb Free Solder Reflow Profile:



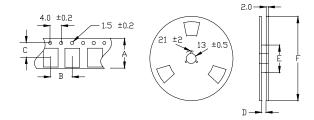
Units are backward compatible with 240°C reflow processes

Ts max to T <sub>∟</sub> (Ramp-up Rate)	3°C / second max	
Preheat		
Temperature min (Ts min)	150°C	
Temperature typ (Ts typ)	175°C	
Temperature max (Ts max)	200°C	
Time (Ts)	60 to180 seconds	
Ramp-up Tate (T <sub>L</sub> to Tp	3°C / second max	
Time Maintained Above		
Temperature (T∟)	217°C	
Time (T <sub>L)</sub>	60 to 150 seconds	
Peak Temperature (Tp)	260°C max for 10 seconds	
Time within 5°C to Peak	20 to 40 seconds	
Temperature (Tp)	20 to 40 seconds	
Ramp-down Rate	6°C / second max	
Tune 25°C to Peak Temperature	8 minutes max	

#### **Package Information:**

MSL = N.A. (package does not contain plastic; storage life is unlimited under normal room conditions). Termination = e4 (Au over Ni over W base metallization).

### **Tape and Reel Information:**



Quantity per Reel	3000	
Α	8.0 ±0.2	
В	4.0 ±0.1	
С	3.5 ±0.05	
D	9.0 ±0.3	
Е	60 / 80	
F	180 / 250	

Dimensions: mm